

Reliability Test Result Report

LSI Type : BD52E42G-MTR

Package Type : SSOP5

				PASS	
Reliability Test Result]	TEST METHOD		DURATION	n	Pn
*2 Resistance to	After the moisture soaking treatment,care	γ			
soldering heat	out the soldering heat stress(IR reflow :peak260°C)				
		JEITA ED4701-301	10sec	22	0
*1 Pressure Cooker	Storage at 121°C/100% (2.026x10 ⁵ Pa)	-	192hour	22	0
*1 Temperature Cycling	Tstg min (30min) / Tstg max (30min)	JEITA ED4701-105	500cycles	22	0
High Temperature Storage	Storage at Tstg max	JEITA ED4701-201	2000hours	22	0
Low Temperature Storage	Storage at Tstg min	JEITA ED4701-202	2000hours	22	0
*1 Temperature Humidity	Place at 85°C/85%				
Storage		JEITA ED4701-103	2000hours	22	0
*1 Temperature Humidity	Apply the specified voltage at				
Bias	85°C/85%	JEITA ED4701-102	2000hours	22	0
High Temperature	Apply the specified voltage at				
Operation Life	Topr max	JEITA ED4701-101	2000hours	22	0
				(pcs)	(pcs)
Strength Test Result					
ITEM	TEST METHOD		DURATION	n	Pn
Terminal strength	Pull force = 1N	JEITA ED4701-401	10sec	5	0
Solderability	Dipping temperature 215°C, (Pb)	JEITA ED4701-303	10sec	22	0
	Dipping temperature 245°C, (Pb free)	JEITA ED4701-303	5sec	22	0
Electro Static Discharge	C=100pF, R=1.5k Ω , 3times, \pm 2000V				
	HBM (Human Body Model)	JEITA ED4701-304	_	5	0
	C=200pF, R=0 Ω , 3times, ± 200 V				
	MM (Machine Model)	-	_	5	0
	±750V				
	CDM (Charged Device Model)	JESD22-C101	_	5	0
Latch Up	Pulse current injection, trigger pulse curr	ent ±100mA			
·	· · · · · · · · · · · · · · · · · · ·	JEITA ED4701-306	_	5	0
				(pcs)	(pcs)

<*1> Soldering Heat examination is executed 3 times for the precondition.

Yoshitaka Ichise

General Manager

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Quality Control Division

LSI Production Headquarters

ROHM Co., Ltd.

Form: 2016.03.01

 $^{*2\}$ Moisture soaking treatment Standard : 85°C 85% 168h / Dry packing : 30°C 70% 192h

Notes

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